

Electronic Patent Application Fee Transmittal

Application Number:	10523524			
Filing Date:	04-Feb-2005			
Title of Invention:	Method of composite injection molding and mold			
First Named Inventor/Applicant Name:	Hiromitsu Seitoh			
Filer:	Bryan H. Davidson/Dawn Barbour			
Attorney Docket Number:	BHD-1226-115			
Filed as Large Entity				
U.S. National Stage under 35 USC 371 Filing Fees				
Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Basic Filing:				
Pages:				
Claims:				
Miscellaneous-Filing:				
Petition:				
Patent-Appeals-and-Interference:				
Post-Allowance-and-Post-Issuance:				
Extension-of-Time:				
Extension - 2 months with \$0 paid	1252	1	490	490

Description	Fee Code	Quantity	Amount	Sub-Total in USD(\$)
Miscellaneous:				
Total in USD (\$)				490